# Image Reject Mixer 8 - 26 GHz



MAMX-011040

Rev. V2

#### **Features**

- · Passive Mixer—No Bias required
- Usable as IR Downconverter or as Single Sideband (SSB) Upconverter
- Wideband 8-26 GHz RF/LO range
- Low Conversion Loss: 8 dB
- Operates at low LO level of +10 dBm
- LO Power Operating Range: 10 18 dBm
- Nominal LO drive of +14 dBm
- High Linearity: 17 dBm IIP3
- High Image Rejection: 22 dBc
- Wide IF Bandwidth: DC to 4.0 GHz
- High Isolation
- Package Size: 4 mm QFN 24-lead
- RoHS\* Compliant

#### **Applications**

Test & Measurement, Microwave Radio, and Radar

### **Description**

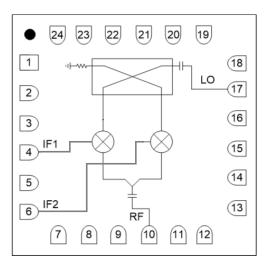
MAMX-011040 is an image-reject passive diode mixer MMIC. The mixer offers low conversion loss, high linearity, high image rejection over wideband 8-26 GHz range, and wide IF bandwidth up to 4GHz. The nominal LO drive is +14 dBm. However, the MAMX-011040 exhibits excellent Conversion Loss and Image Rejection performance at 10dBm. The overall LO operating range is +10 dBm to +18 dBm. The image-reject circuit configuration provides excellent port isolation while internal 50-ohm matching simplifies its application.

## Ordering Information<sup>1,2</sup>

Part Number	Package
MAMX-011040	Bulk
MAMX-011040-TR0100	100 Piece Reel
MAMX-011040-TR0500	500 Piece Reel
MAMX-011040-SB1	Sample Board

- 1. Reference Application Note M513 for reel size information.
- 2. All sample boards include 5 loose parts.

#### **Functional Schematic**



## Pin Configuration<sup>3</sup>

Pin#	Function		
1 - 3	Ground		
4	IF1		
5	Ground		
6	IF2		
7 - 9	Ground		
10	RF		
11 - 16	Ground		
17	LO		
18 - 24	Ground		
25	Paddle <sup>4</sup>		

- 3. MACOM recommends connecting unused package pins to ground
- The exposed pad centered on the package bottom must be connected to RF, DC and thermal ground.

<sup>\*</sup> Restrictions on Hazardous Substances, compliant to current RoHS EU directive.



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## Electrical Specifications<sup>5</sup>: $F_{IF} = 100$ MHz, $P_{LO} = +14$ dBm, $T_A = +25$ °C, $Z_0 = 50$ $\Omega$

Parameter	Test Conditions	Units	Min.	Тур.	Max.
LO and RF Frequency	_	GHz	8	_	26
IF Frequency	_	GHz	0	_	4
LO Power	_	dBm	_	14	_
Conversion Loss	8 -12 GHz 12 - 26 GHz	dB	_	8 9	9.5 11.5
Input P1dB	_	dBm		9	_
Input IP3	P <sub>RF</sub> = -10 dBm/tone, Δf = 1 MHz	dBm		17	
Input IP2	_	dBm	_	40	_
LO-to-RF Isolation	_	dB	_	35	_
LO-to-IF Isolation	_	dB	_	35	_
RF-to-IF Isolation	_	dB		15	_
Image Rejection	_	dBc	17	22	_
Amplitude Imbalance	_	dB	_	±2.0	_
Phase Imbalance	_	0	_	±10.0	_
RF Return Loss	_	dB	_	6	_
IF Return Loss	_	dB		12	

<sup>5.</sup> All specifications refer to down-conversion operation with upper sideband selected, unless otherwise noted.

## Absolute Maximum Ratings<sup>4,5</sup>

Parameter	Absolute Maximum		
LO Power	+23 dBm		
RF or IF Power	+20 dBm		
Junction Temperature <sup>6</sup>	+150°C		
Operating Temperature	-40°C to +85°C		
Storage Temperature	-65°C to +150°C		

- Exceeding any one or combination of these limits may cause permanent damage to this device.
- MACOM does not recommend sustained operation near these survivability limits.
- 8. Operating at nominal conditions with  $T_J \le +150^{\circ}C$  will ensure MTTF > 1 x  $10^6$  hours. Thermal resistance,  $\Theta_{JC}$  is  $85^{\circ}C/W$ .

## **Handling Procedures**

Please observe the following precautions to avoid damage:

#### Static Sensitivity

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 1A devices.

## Assembly Information

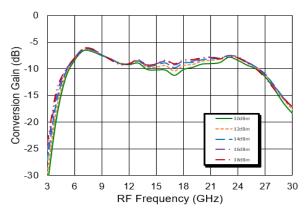
- Do not subject the device to excessive force, especially at elevated temperatures >60°C.
- No-clean flux is required for assembly. Post SMT washing is not recommended.



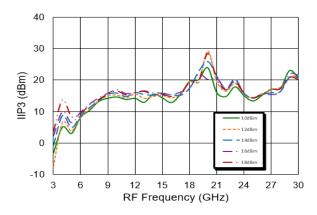
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## Typical Performance Curves Lower Side Band (LSB) High Side LO at 100 MHz IF

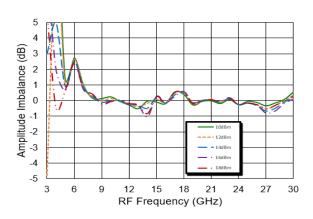
## Down Conversion Gain over LO drive Data captured with 90deg hybrid at 100MHz IF



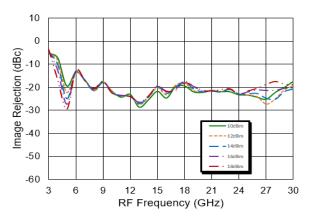
IIP3 over LO drive
Data captured with 90deg hybrid at 100MHz IF



Amplitude Imbalance over LO drive

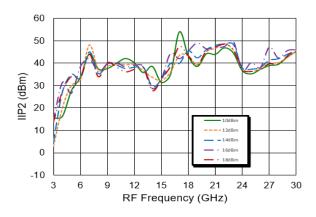


Down Conversion Image Rejection over LO drive Data captured with 90deg hybrid at 100MHz IF

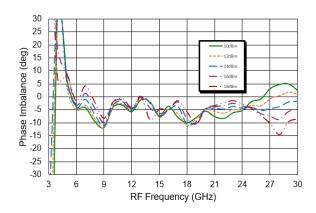


IIP2 over LO drive

Data captured with 90deg hybrid at 100MHz IF



Phase Imbalance over LO drive



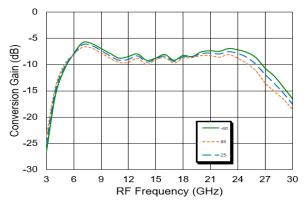


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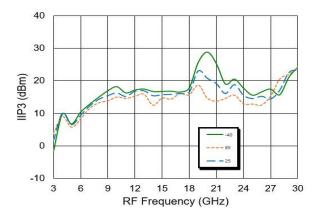
## Typical Performance Curves Lower Side Band (LSB) High Side LO at 100 MHz IF

Down Conversion Gain over temperature

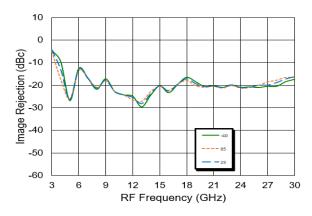
Data captured with 90deg hybrid at 100MHz IF



IIP3 over temperature
Data captured with 90deg hybrid at 100MHz IF

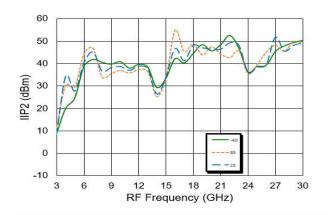


Down Conversion Image Rejection over temperature
Data captured with 90deg hybrid at 100MHz IF



IIP2 over temperature

Data captured with 90deg hybrid at 100MHz IF



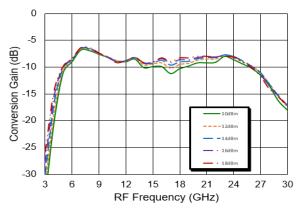


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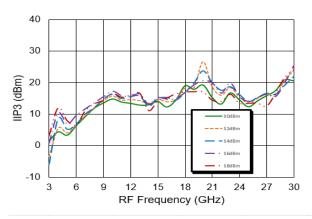
### Typical Performance Curves Upper Side Band (USB) Low Side LO at 100 MHz IF

Down Conversion Gain over LO drive

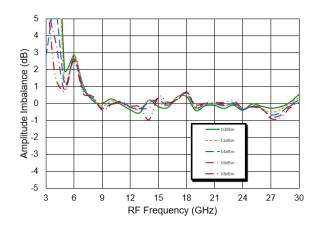
Data captured with 90deg hybrid at 100MHz IF



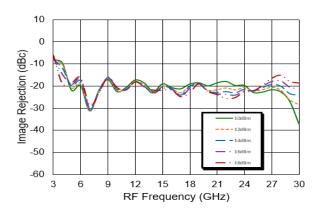
IIP3 over LO drive
Data captured with 90deg hybrid at 100MHz IF



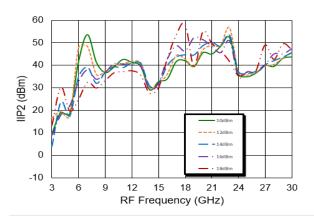
Amplitude Imbalance over LO drive



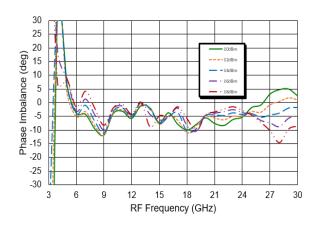
Down Conversion Image Rejection over LO drive Data captured with 90dea hvbrid at 100MHz IF



IIP2 over LO drive
Data captured with 90deg hybrid at 100MHz IF



Phase Imbalance over LO drive



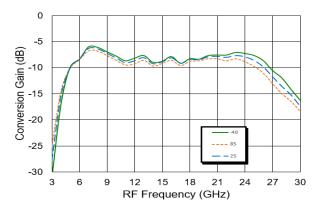


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## Typical Performance Curves Upper Side Band (USB) Low Side LO at 100 MHz IF

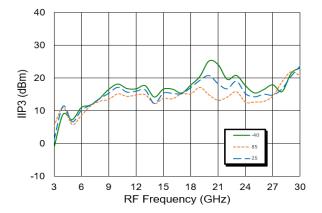
Down Conversion Gain over temperature

Data captured with 90deg hybrid at 100MHz IF

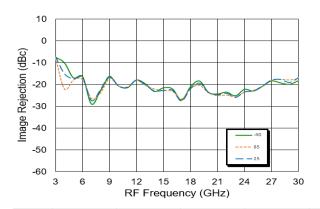


IIP3 over temperature

Data captured with 90deg hybrid at 100MHz IF

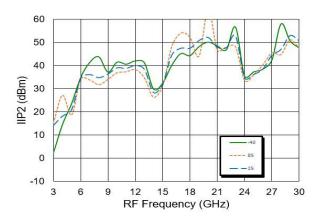


Down Conversion Image Rejection over temperature Data captured with 90deg hybrid at 100MHz IF



IIP2 over temperature

Data captured with 90deg hybrid at 100MHz IF



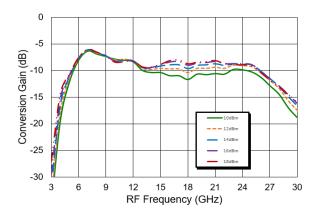


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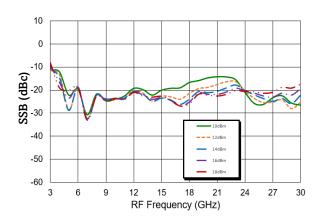
## Typical Performance Curves Lower Side Band (LSB) High Side LO at 100 MHz IF

Up Conversion Gain over LO drive

Data captured with 90deg hybrid at 100MHz IF

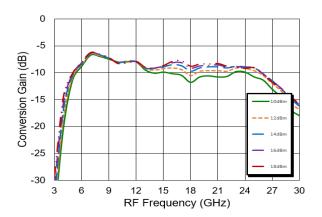


Up Conversion SSB over LO drive
Data captured with 90deg hybrid at 100MHz IF

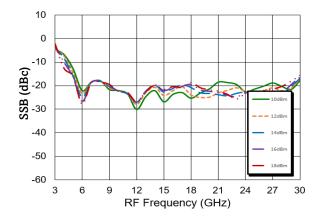


## Typical Performance Curves Upper Side Band (USB) Low Side LO

Up Conversion Gain over LO drive
Data captured with 90deg hybrid at 100MHz IF



Up Conversion SSB over LO drive
Data captured with 90deg hybrid at 100MHz IF

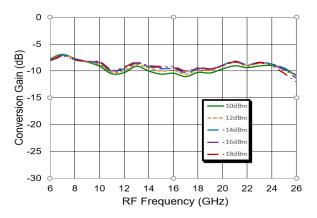




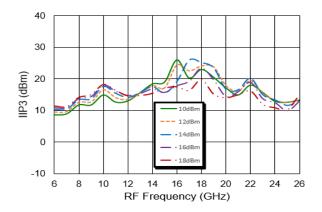
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## Typical Performance Curves Lower Side Band (LSB) High Side LO at 2GHz IF

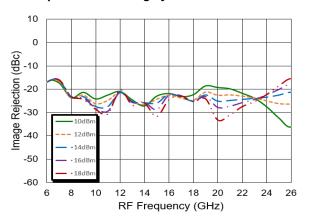
## Down Conversion Gain over LO drive Data captured with 90deg hybrid at 2GHz IF



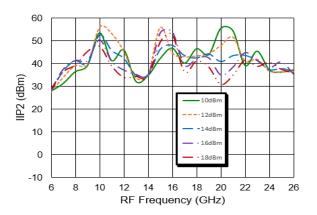
IIP3 over LO drive
Data captured with 90deg hybrid at 2GHz IF



#### Down Conversion Image Rejection over LO drive Data captured with 90deg hybrid at 2GHz IF



IIP2 over LO drive
Data captured with 90deg hybrid at 2GHz IF

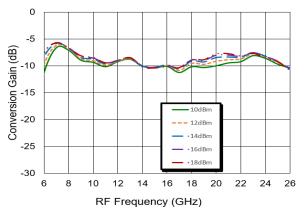




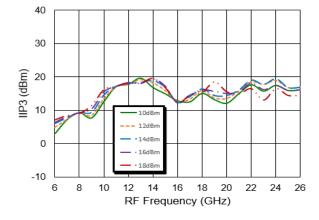
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## Typical Performance Curves Lower Side Band (USB) Low Side LO at 2GHz IF

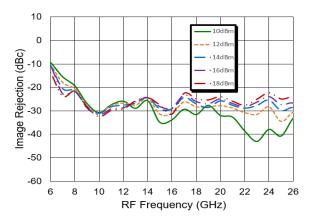
## Down Conversion Gain over LO drive Data captured with 90deg hybrid at 2GHz IF



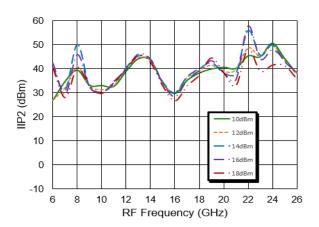
IIP3 over LO drive Data captured with 90deg hybrid at 2GHz IF



## Down Conversion Image Rejection over LO drive Data captured with 90deg hybrid at 2GHz IF



IIP2 over LO drive
Data captured with 90deg hybrid at 2GHz IF

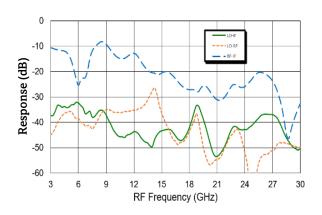




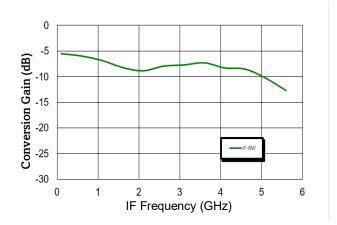
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## **Typical Performance Curves**

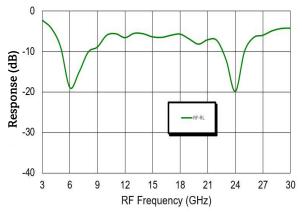
#### Isolations



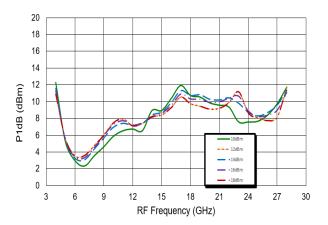
#### IF Bandwidth



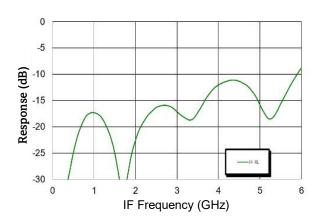
#### RF Return Loss



#### P1dB vs LO power



#### IF Return Loss





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## MxN Spurious Rejection @ IF Port

RF 15.9 GHz at -10 dBm, LO 16 GHz at +14 dBm All values in dBc below the IF output power level

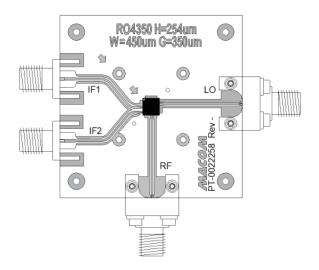
	nxLO				
mxRF	0	1	2	3	4
0	х	11	14	28	Х
1	22	0	52	64.1	46
2	82	68	61	58.6	73
3	74.9	Х	90	79	78
4	Х	х	х	100.2	89.3

#### **LO Harmonics**

LO +14 dBm Values in dBc below input LO level measured at RF

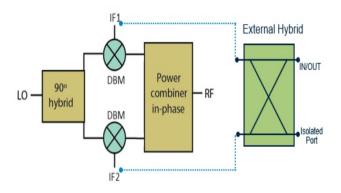
n LO spur at RF port					
LO GHz	1	2	3	4	
6	37.9	46.1	60.8	50.2	
8	46.6	53.9	51.9	59.1	
10	42.3	56.6	51.2	51.4	
12	37.9	56.6	81.2	38.2	
14	30.4	52.1	47.8	N/A	
16	42.8	52.1	47.8	N/A	
18	42.6	83.3	N/A	N/A	
20	55.4	52.6	N/A	N/A	
22	39.9	54.4	N/A	N/A	
24	52.7	53.6	N/A	N/A	
26	N/A	N/A	N/A	N/A	

## Sample Board



- Material: Rogers 4350B
- Dielectric thickness 0.254 mm
- Finished copper thickness 17 microns (0.5 oz) plated to 44 microns +/- 10 microns
- Finish both sides: ENIG, 0.05-0.15 μm gold over 3-6 μm nickel
- DXF available on request

### **Application Schematic**



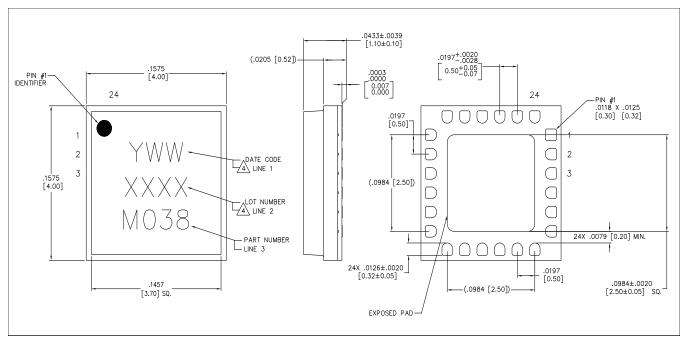
#### **External Hybrid**

- Down conversion and Up conversion data captured with external hybrid 90° coupler part number: Innovative IPP-2345.
- RF Upper Side Band (USB) mode connect hybrid 0° port to IF1 mixer port, 90° hybrid port to IF2 mixer port.
- RF Lower Side Band (LSB) mode connect hybrid 0° port to IF2 mixer port, 90° hybrid port to IF1 mixer port.



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#### Lead-Free 4 mm 24-Lead AQFN<sup>†</sup>



<sup>†</sup> Reference Application Note S2083 for lead-free solder reflow recommendations. Meets JEDEC moisture sensitivity level 3 requirements. Plating is NiPdAu

# Image Reject Mixer 8 - 26 GHz



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